

RF Transformer

50Ω 700 to 2700 MHz 1:1 Ratio

TCW1-2700-2+



Generic photo used for illustration purposes only

CASE STYLE: JC0603C

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Available Tape and Reel at no extra cost

Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500, 1000, 4000

Maximum Ratings

Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
Input RF Power	0.5W

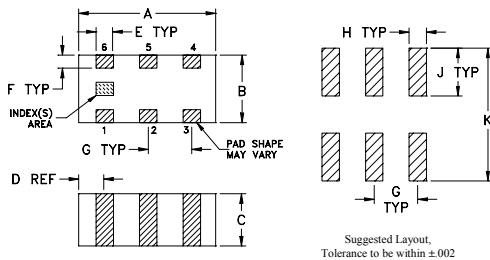
Permanent damage may occur if any of these limits are exceeded.

Pad Connections

PRIMARY DOT (Unbalanced Port)	1
GND or DC feed + RF	2
SECONDARY DOT (Balanced)	3
SECONDARY (Balanced)	4
NO CONNECTION	6
GND	5

Outline Drawing

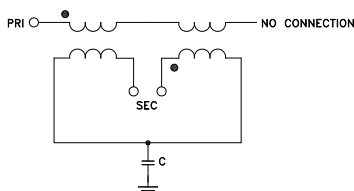
PCB Land Pattern



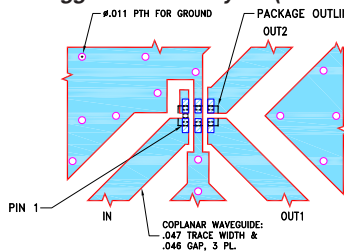
Outline Dimensions (inch mm)

A	B	C	D	E	F
.063	.031	.024	.012	.008	.006
1.60	0.79	0.61	0.30	0.20	0.15
G	H	J	K	wt	
.020	.010	.022	.053	grams	
0.51	0.25	0.56	1.35	0.005	

Configuration R



Demo Board MCL P/N: TB-912+
Suggested PCB Layout (PL-574)



NOTES:

1. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020±.0015. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
3. DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
4. DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Features

- wideband, 700 to 2700 MHz
- miniature size 0603 (1.6x0.8mm)
- LTCC construction
- low cost
- aqueous washable

Applications

- WLAN
- A/D conversion
- WiFi
- transmitters and receivers
- cellular

Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			1		
Frequency Range		700		2700	MHz
Insertion Loss*	700 - 2700		1.4	2.0	dB
Amplitude Unbalance	700 - 2700		1	2	dB
Phase Unbalance †	700 - 2700		12	15	Degree

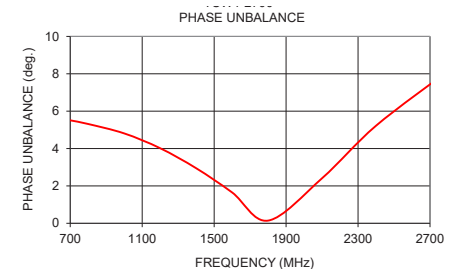
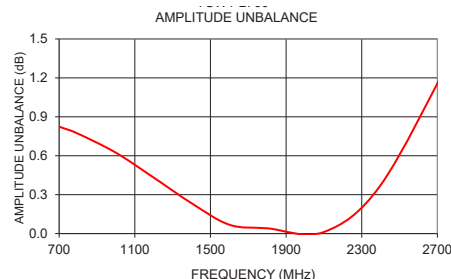
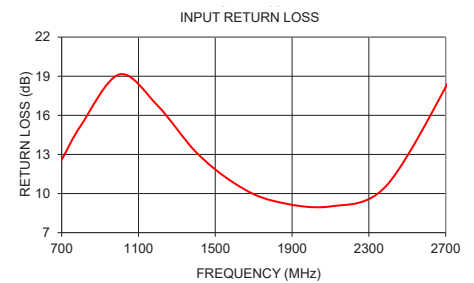
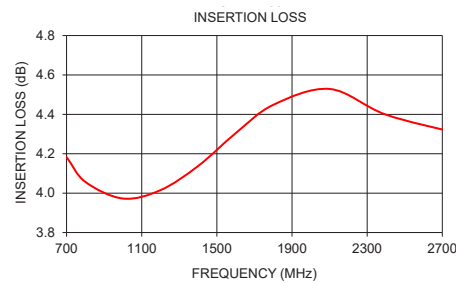
* Reference Demo Board TB-912+

† Relative to 180°

Typical Performance Data at 25°C**

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
700.0	4.18	12.59	0.82	5.51
800.0	4.06	15.22	0.77	5.31
1000.0	3.97	19.14	0.62	4.81
1200.0	4.02	16.74	0.43	4.02
1400.0	4.14	13.18	0.23	2.95
1600.0	4.30	10.79	0.07	1.65
1800.0	4.45	9.44	0.04	0.14
2100.0	4.53	9.01	0.01	2.41
2400.0	4.40	10.75	0.37	5.22
2700.0	4.27	16.86	1.10	8.15

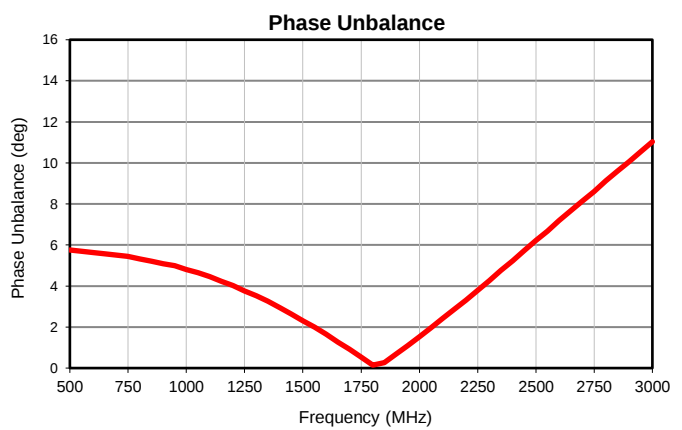
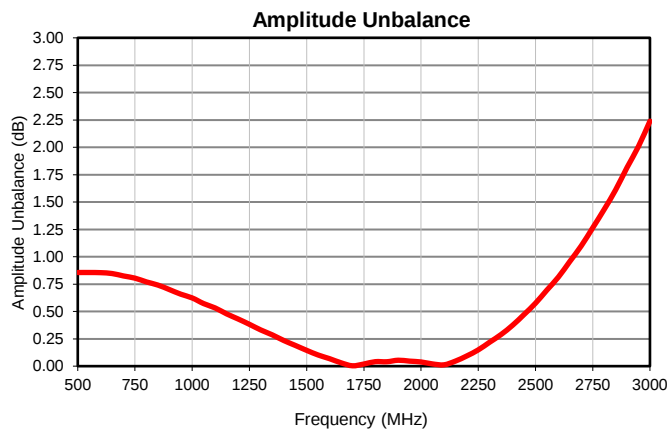
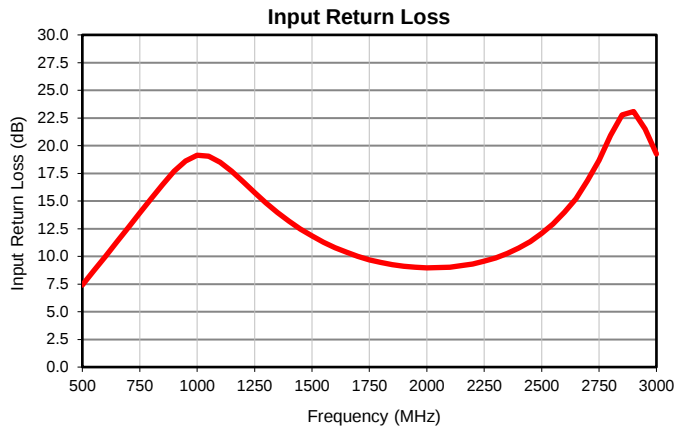
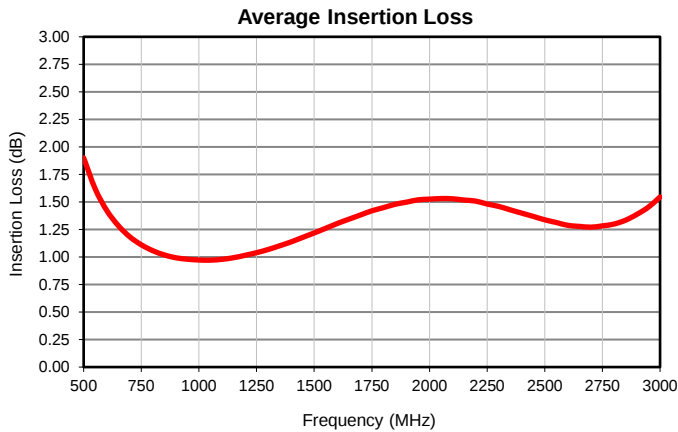
** Measured with Agilent E5071B network analyzer using impedance conversion and port extension.



Typical Performance Data

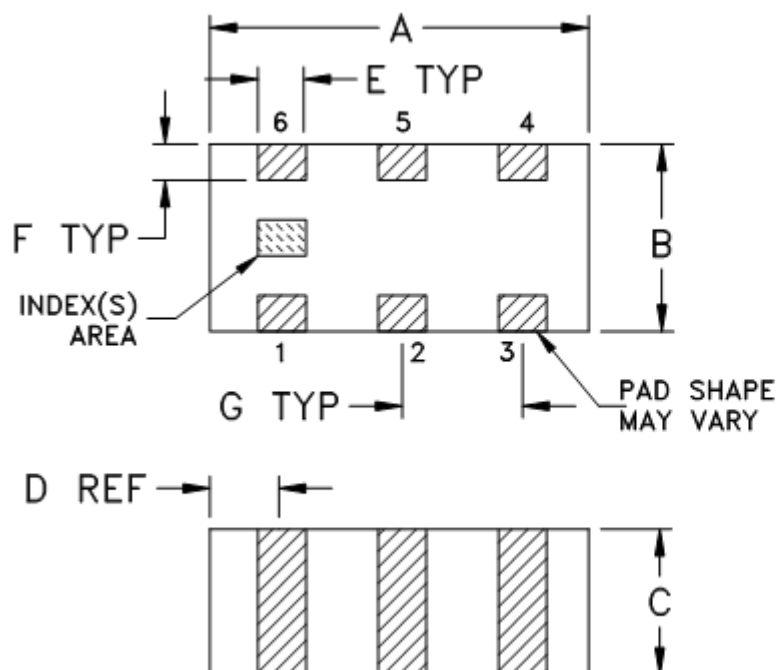
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
500	1.90	7.41	0.86	5.76
550	1.62	8.70	0.86	5.70
600	1.42	9.97	0.85	5.63
650	1.29	11.29	0.85	5.57
700	1.18	12.59	0.82	5.51
750	1.11	13.93	0.80	5.44
800	1.06	15.22	0.77	5.31
850	1.02	16.48	0.74	5.22
900	0.99	17.68	0.70	5.09
950	0.98	18.62	0.66	4.99
1000	0.97	19.14	0.62	4.81
1050	0.97	19.04	0.57	4.65
1100	0.98	18.51	0.53	4.46
1150	0.99	17.69	0.48	4.23
1200	1.02	16.74	0.43	4.02
1250	1.04	15.76	0.38	3.77
1300	1.07	14.83	0.33	3.52
1350	1.10	13.95	0.29	3.25
1400	1.14	13.18	0.23	2.95
1450	1.18	12.46	0.19	2.64
1500	1.22	11.84	0.14	2.31
1550	1.26	11.27	0.10	2.00
1600	1.30	10.79	0.07	1.65
1650	1.34	10.37	0.03	1.27
1700	1.38	10.01	0.00	0.92
1750	1.42	9.69	0.02	0.53
1800	1.45	9.44	0.04	0.14
1850	1.48	9.24	0.04	0.27
1900	1.50	9.10	0.05	0.69
1950	1.52	9.01	0.05	1.10
2000	1.53	8.95	0.04	1.53
2050	1.53	8.98	0.02	1.96
2100	1.53	9.01	0.01	2.41
2150	1.52	9.16	0.05	2.87
2200	1.51	9.31	0.09	3.31
2250	1.48	9.58	0.15	3.79
2300	1.46	9.86	0.22	4.26
2350	1.43	10.27	0.29	4.76
2400	1.40	10.75	0.37	5.22
2450	1.37	11.34	0.47	5.72
2500	1.34	12.07	0.58	6.22
2550	1.31	12.91	0.70	6.68
2600	1.29	13.98	0.81	7.19
2650	1.28	15.20	0.96	7.67
2700	1.27	16.86	1.10	8.15
2750	1.28	18.66	1.26	8.61
2800	1.30	20.92	1.43	9.12
2850	1.33	22.76	1.61	9.59
2900	1.39	23.08	1.82	10.06
2950	1.45	21.50	2.01	10.54
3000	1.55	19.26	2.24	11.03

Typical Performance Data

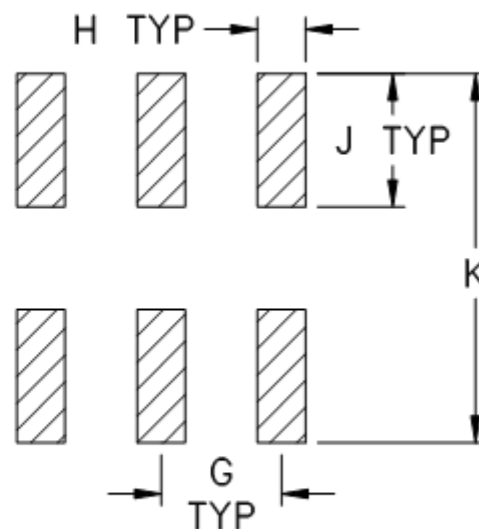


Outline Dimensions

JC0603C



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
JC0603C	.063 (1.60)	.031 (0.80)	.024 (0.60)	.012 (0.30)	.008 (0.20)	.006 (0.15)	.020 (0.50)	.010 (0.25)	.022 (0.55)	0.053 (1.35)	.005

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R

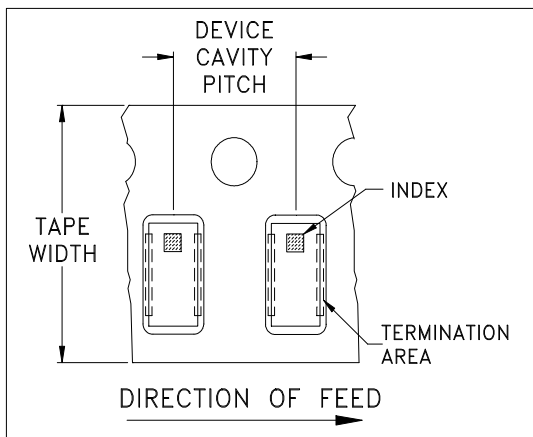


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

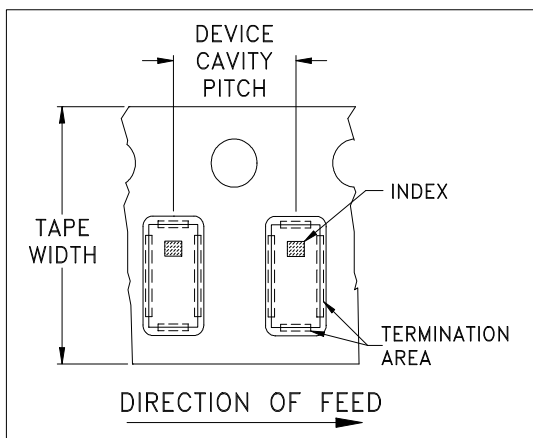


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	JV1210C-1
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



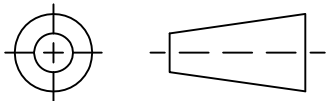
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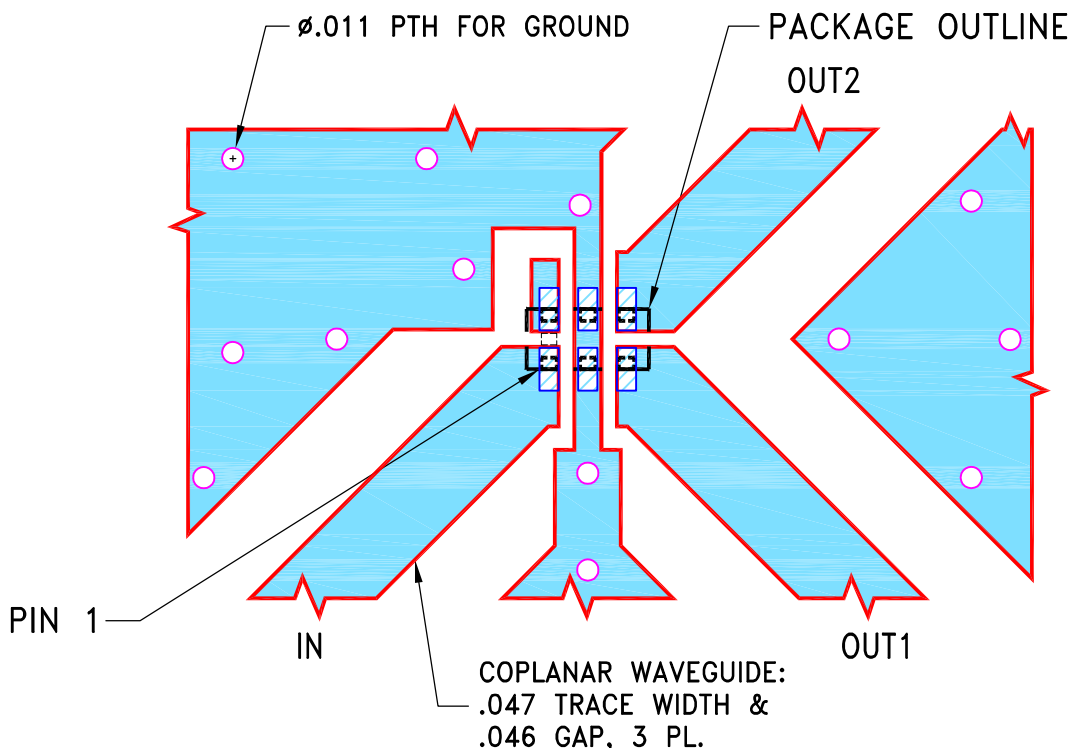
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M166452	NEW RELEASE	02/22/18	ITG	BK

SUGGESTED MOUNTING CONFIGURATION
FOR JC0603C CASE STYLE, "06TR01" PIN CODE



NOTES:

1. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS $.020 \pm .0015$. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

ITG

02/20/18

CHECKED

GF

02/21/18

APPROVED

BK

02/22/18



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, 06TR01, JC0603C, TB-912+

SIZE

CODE IDENT

DRAWING NO:

REV:

A

15542

98-PL-574

OR

FILE:

98PL574

SCALE:

10:1

SHEET:

1 OF 1

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A